

Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Typical Applications

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

Mechanical Data

- **Package:** DO-214AC (SMA)
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end

■ Maximum Ratings (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GS2AA	GS2BA	GS2DA	GS2GA	GS2JA	GS2KA	GS2MA
Device marking code			GS2AA	GS2BA	GS2DA	GS2GA	GS2JA	GS2KA	GS2MA
Maximum Repetitive peak reverse voltage	V _{RRM}	V	50	100	200	400	600	800	1000
Maximum RMS Voltage	V _{RMS}	V	35	70	140	280	420	560	700
Maximum DC Blocking Voltage	V _{DC}	V	50	100	200	400	600	800	1000
Average rectified output current @60Hz sine wave, Resistance load, TL (FIG.1)	I _O	A	2						
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, T _j =25°C	I _{FSM}	A	50						
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, T _j =25°C			100						
Current squared time @1ms≤t≤8.3ms T _j =25°C	I ² t	A ² s	10.735						
Storage temperature	T _{stg}	°C	-55 ~ +150						
Junction temperature	T _j	°C	-55 ~ +150						

■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GS2AA	GS2BA	GS2DA	GS2GA	GS2JA	GS2KA	GS2MA
Maximum instantaneous forward voltage	V _F	V	I _{FM} =2.0A	1.1						
Maximum DC reverse current at rated DC blocking voltage	I _R	μA	T _j =25°C	5						
			T _j =125°C	100						
Typical junction capacitance	C _j	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	12						

■ Thermal Characteristics ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	GS2AA	GS2BA	GS2DA	GS2GA	GS2JA	GS2KA	GS2MA
Typical Thermal Resistance	$R_{\theta J-A}^{(1)}$	$^{\circ}\text{C/W}$	65						
	$R_{\theta J-L}^{(1)}$		20						
	$R_{\theta J-C}^{(1)}$		18						

Note

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

■ Characteristics (Typical)

FIG.1: Io-TL Curve

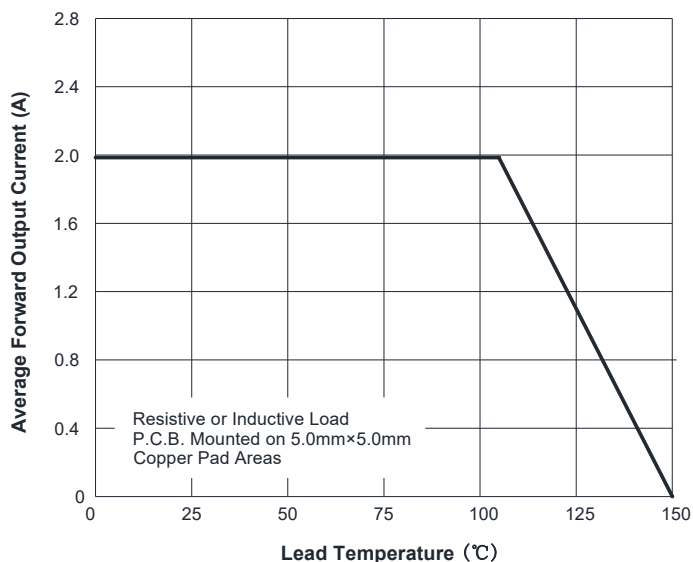


FIG.2: Forward Surge Current Capability

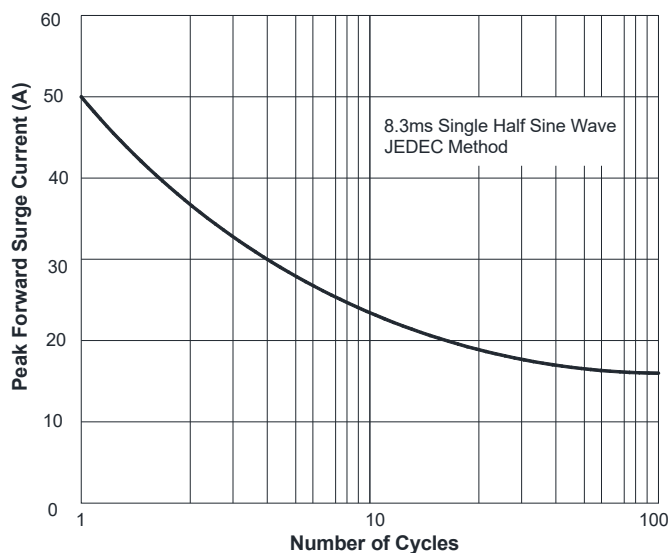


FIG.3: Typical Forward Voltage

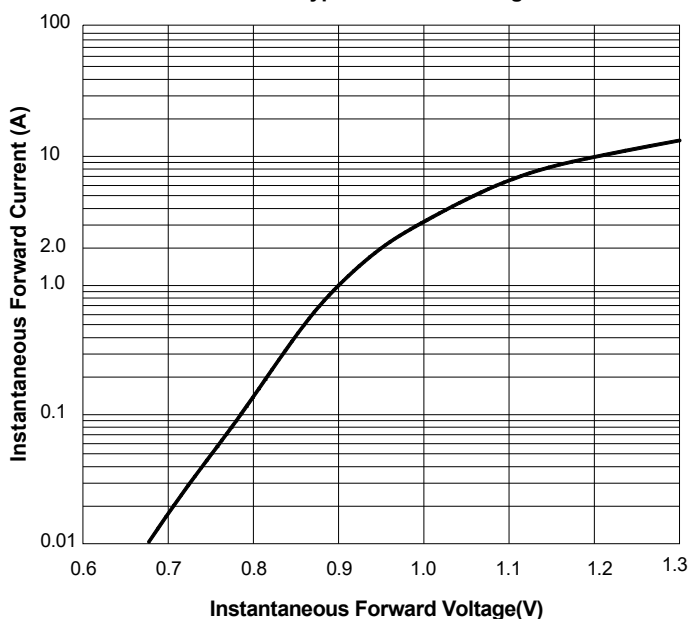
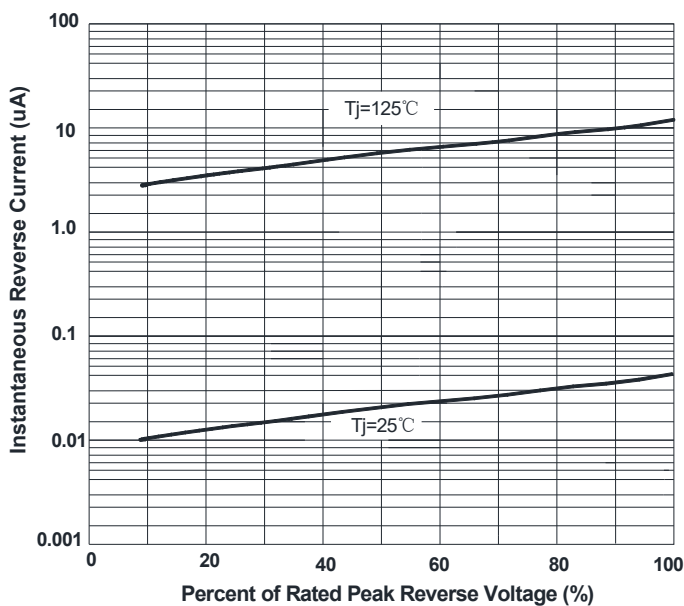


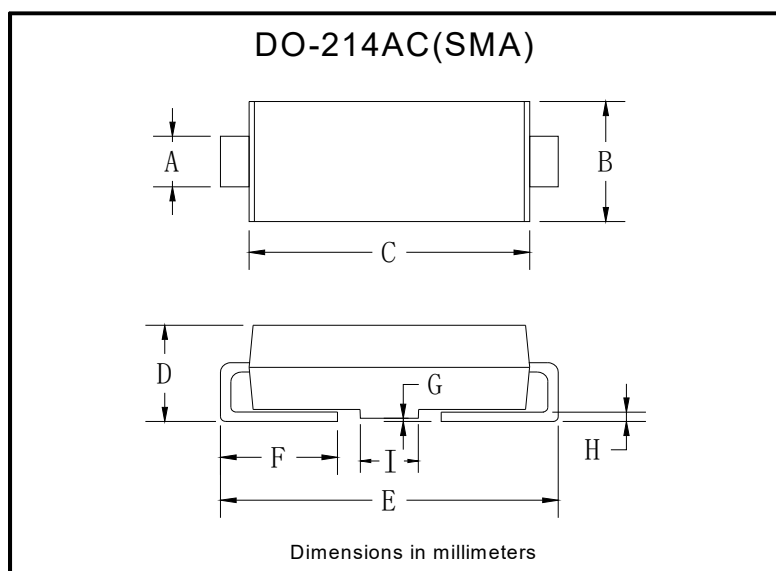
FIG.4: Typical Reverse Characteristics



■ **Ordering Information (Example)**

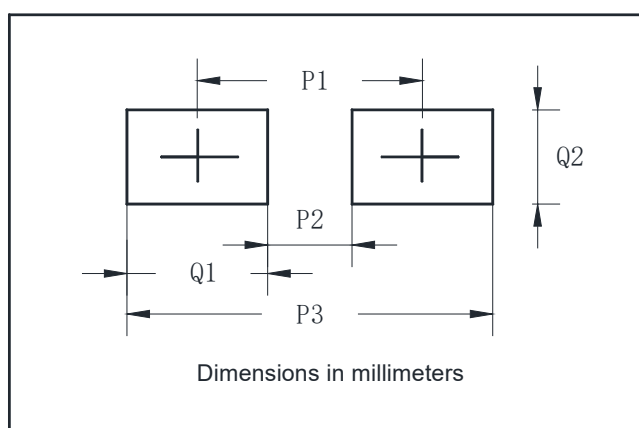
PREFERRED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GS2AA-GS2MA	F1	Approximate 0.059	5000	/	80000	13" reel
GS2AA-GS2MA	F2	Approximate 0.059	7500	/	120000	13" reel
GS2AA-GS2MA	F3	Approximate 0.059	7500	/	60000	13" reel
GS2AA-GS2MA	F4	Approximate 0.059	1800	14400	57600	7" reel
GS2AA-GS2MA	F5	Approximate 0.059	2000	16000	64000	7" reel
GS2AA-GS2MA	F6	Approximate 0.059	5000	/	100000	13" reel

■ **Outline Dimensions**



DO-214AC(SMA)		
Dim	Min	Max
A	1.25	1.58
B	2.40	2.83
C	4.00	4.75
D	1.90	2.30
E	4.93	5.28
F	0.76	1.41
G	0.05	0.20
H	0.15	0.31
I	1.70	2.10

■ **Suggested Pad Layout**



DO-214AC(SMA)	
Dim	Millimeters
P1	4.00
P2	1.50
P3	6.50
Q1	2.50
Q2	1.70